

Atmega 328 architecture

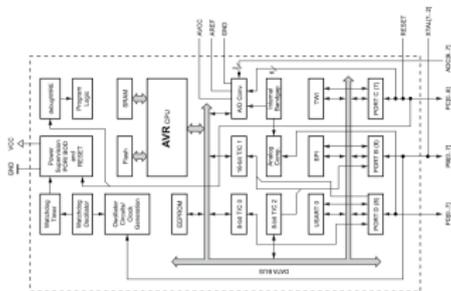


FIG 3. Atmega328 block diagram

Atmega 328 architecture

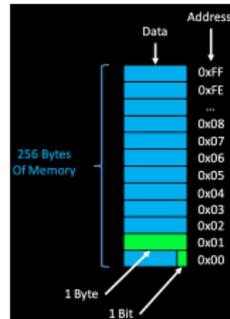
- Harvard architecture
- Programmable memory: 32K flash
- Data memory 2K SRAM
- Long term memory EEPROM: 1K
- Maximum CPU speed: 20 MHz
- 32 8-bit general purpose registers in SRAM memory space
- 3 8-bit Ports (B, C, D)—Each port controlled by



ATMEGA128 memory system

Review: MCU memory

- Bit
 - Building Block of Memory.
 - Stores 1 piece of Boolean information (0 or 1)
- Byte – 8 Bits. Usually minimum unit for access
- Embedded systems usually have a few kilobytes of memory.
- Memory is one of the limiting factors in embedded systems



Review: MCU memory

- Computer Systems contain a mixture of memories
- Memory considerations Technology:
 - Capacity
 - Power
 - Speed/Latency
 - Price

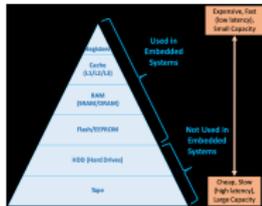
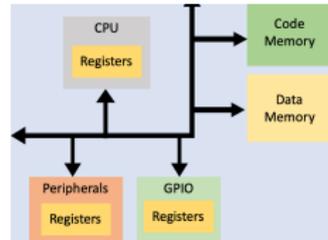


FIG 4. Memory hierarchy
The memory hierarchy separates computer storage into a hierarchy based on response time. Fast memory is usually small and expensive. Embedded systems are usually limited to small memory

Review: MCU memory

- An executable program consists of program code and program data compiled for a particular architecture and platform
- Three types of storage needed for a program
 - Code Memory
 - Data Memory
 - Runtime State of Program
- The compiler tracks and maps memory from program code and program data into segments



AVR IO port

AVR input/output (I/O) port

- Read-Modify-Write capability, i.e., you can change pin direction, pin value, or pin pull-up resistor without effecting any other pins in the port
- All AVR ports have:
 - bit-selectable pull-up resistors
 - bit-selectable tri-state outputs
 - schmitt trigger (i.e., comparator circuit) input buffers
 - are synchronized to the

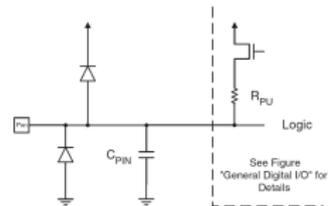


FIG 5. AVR I/O Pin Equivalent Schematic

The AVR I/O ports are the path to the outside world. The ports has protection diodes and programmable pull-up resistor

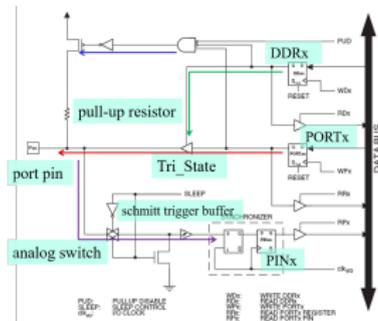


FIG 6. The ports are bi-directional I/O ports with optional internal pull-ups.

TAB 1. Absolute Maximum Ratings

Operating Temperature	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Voltage on any Pin except RESET with respect to Ground	-0.5V to $V_{CC}+0.5V$
Voltage on RESET with respect to Ground	-0.5V to +13.0V
Maximum Operating Voltage	6.0V
DC Current per I/O Pin	40.0 mA
DC Current V_{CC} and GND Pins	200.0 - 400.0mA

TAB 2. AVR I/O port DC characteristics

$T_A = -40^{\circ}C$ to $85^{\circ}C$, $V_{CC} = 2.7V$ to $5.5V$ (unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{IL}	Input Low Voltage except XTAL1 and RESET pins	$V_{CC} = 2.7V - 5.5V$	-0.5		$0.2 V_{CC}^{(1)}$	V
V_{IH}	Input High Voltage except XTAL1 and RESET pins	$V_{CC} = 2.7V - 5.5V$	$0.6 V_{CC}^{(2)}$		$V_{CC} + 0.5$	V
V_{OL1}	Input Low Voltage XTAL1 pin	$V_{CC} = 2.7V - 5.5V$	-0.5		$0.1 V_{CC}^{(3)}$	V
V_{OH1}	Input High Voltage XTAL1 pin	$V_{CC} = 2.7V - 5.5V$	$0.7 V_{CC}^{(2)}$		$V_{CC} + 0.5$	V
V_{OL2}	Input Low Voltage RESET pin	$V_{CC} = 2.7V - 5.5V$	-0.5		$0.2 V_{CC}^{(3)}$	V
V_{OH2}	Input High Voltage RESET pin	$V_{CC} = 2.7V - 5.5V$	$0.6 V_{CC}^{(2)}$		$V_{CC} + 0.5$	V
V_{OL}	Output Low Voltage ⁽⁴⁾ (Pins A,B,C,D, E, F, G)	$I_{OL} = 20mA$, $V_{CC} = 5V$ $I_{OL} = 10mA$, $V_{CC} = 3V$			0.7 0.5	V
V_{OH}	Output High Voltage ⁽⁴⁾ (Pins A,B,C,D, E, F, G)	$I_{OH} = -20mA$, $V_{CC} = 5V$ $I_{OH} = -10mA$, $V_{CC} = 3V$	4.2 2.2		V	V
I_L	Input Leakage Current I/O Pin	$V_{CC} = 5.5V$, pin low (absolute value)		1.0		μA
I_{IH}	Input Leakage Current I/O Pin	$V_{CC} = 5.5V$, pin high (absolute value)		1.0		μA
R_{RST}	Reset Pull-up Resistor		30	85		Ω
R_{PK2}	PEN Pull-up Resistor		30	60		k Ω
R_{PJ}	I/O Pin Pull-up Resistor		20	50		Ω

TAB 3. AVR I/O port DC characteristics (continued)

$T_A = 40^{\circ}C$ to $85^{\circ}C$, $V_{CC} = 2.7V$ to $5.5V$ (unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Current	Active (MHz), $V_{CC} = 3V$ (Xtango328L)		9	5.5	mA
		Active (MHz), $V_{CC} = 5V$ (Xtango328L)		17	19	
		Idle (MHz), $V_{CC} = 3V$ (Xtango328L)		2	2.5	
V_{CC}	Power-Down Mode	Idle (MHz), $V_{CC} = 5V$ (Xtango328L)		8	11	μA
		SDT enabled, $V_{CC} = 3V$ HST disabled, $V_{CC} = 3V$		< 15	25	
V_{CC0}	Analog Comparator Input Offset Voltage	$V_{CC} = 5V$ $V_{DD} = V_{CC0}$		40		mV
V_{CC0}	Analog Comparator Input Leakage Current	$V_{CC} = 5V$ $V_{DD} = V_{CC0}$	-80		80	nA
V_{CC0}	Analog Comparator Propagation Delay	$V_{CC} = 2.7V$ $V_{DD} = 5.5V$		190		ns

Notes: 1. "Min" means the highest value when the pin is guaranteed to be read low.
2. "Max" means the lowest value when the pin is guaranteed to be read as high.
3. Although each I/O port can sink more than the test conditions (20mA at $V_{CC} = 5V$, 10mA at $V_{CC} = 3V$) under steady state conditions (not switching), the following must be observed:
TCPP and OPMNML Package:
1) The sum of all I/Os, for all pins, should not exceed 1000mA.
2) The sum of all I/Os, for ports A0 - A7, G2, G3, -C7 should not exceed 100mA.
3) The sum of all I/Os, for ports D0 - D3, D4 - D7, -D4, -D7 should not exceed 100mA.
4) The sum of all I/Os, for ports B0 - B7, -B4, -B7 should not exceed 100mA.
5) The sum of all I/Os, for ports F0 - F7, should not exceed 100mA.
6) I/Os, across the test condition, V_{IL}, may exceed the related specifications. Pins are not guaranteed to sink current greater than the listed test condition.
7) Although each I/O port can source more than the test conditions (20mA at $V_{CC} = 5V$, 10mA at $V_{CC} = 3V$) under steady state conditions (not switching), the following must be observed:
TCPP and OPMNML Package:
1) The sum of all I/Os, for all pins, should not exceed 1000mA.
2) The sum of all I/Os, for ports A0 - A7, G2, G3, -C7 should not exceed 100mA.
3) The sum of all I/Os, for ports D0 - D3, D4 - D7, -D4, -D7 should not exceed 100mA.
4) The sum of all I/Os, for ports B0 - B7, -B4, -B7 should not exceed 100mA.
5) The sum of all I/Os, for ports F0 - F7, should not exceed 100mA.
6) I/Os across the test condition, V_{OH} may exceed the related specification. Pins are not guaranteed to source current greater than the listed test condition.

AVR MCU connection to a PCB

How to you connect the MCU to a circuit?



FIG 7. ATMEGA128 pin out

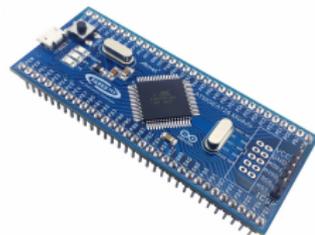
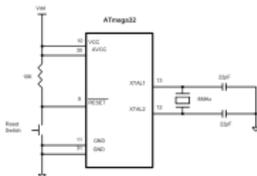


FIG 8. ATMEGA128 Module with Arduino bootloader

AVR pins connection

- **VCC**—this pin provides supply voltage to the chip. The typical voltage source is +5 V. Some AVR family members have lower voltage for VCC pins in order to reduce the noise and power dissipation of the AVR system.
- **AVCC** is the supply voltage pin for Port A and the A/D Converter. It should be externally connected to VCC, even if the ADC is not used.
- **AREF** is the analog reference pin for ADC.



Digital power supply

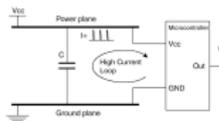


FIG 9. Insufficient power supply decoupling

The capacitor is placed too far away from the microcontroller, creating a large high current loop. As a result of this, noise is spread more easily to other devices on the board, and radiated emission from the board is increased even further. The whole ground plane will act as an antenna for the noise, instead of only the high

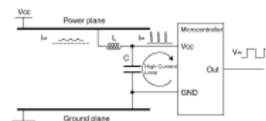


FIG 10. Better placement of the capacitor

The lines that are part of the high current loop are not part of the power or ground planes. This prevents the power and ground planes to spread a lot of noise. Furthermore, a series inductor is inserted to reduce the switching noise on the power plane.

